

# N-Channel Enhancement-Mode Vertical DMOS FET

#### **Features**

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>iss</sub> and fast switching speeds
- Excellent thermal stability
- Integral source-drain diode
- High input impedance and high gain

### **Applications**

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- ▶ Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

### **General Description**

This enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### **Ordering Information**

Part Number	Package Option	Packing		
VN1206L-G	TO-92	1000/Bag		
VN1206L-G P002				
VN1206L-G P003				
VN1206L-G P005	TO-92	2000/Reel		
VN1206L-G P013				
VN1206L-G P014				

<sup>-</sup>G denotes a lead (Pb)-free / RoHS compliant package.

Contact factory for Wafer / Die availablity.

Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

## **Absolute Maximum Ratings**

Parameter	Value
Drain-to-source voltage	BV <sub>DSS</sub>
Drain-to-gate voltage	$BV_{DGS}$
Gate-to-source voltage	±30V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

# **Typical Thermal Resistance**

Package	$ heta_{ja}$
TO-92	132°C/W

## **Product Summary**

$BV_{DSS}/BV_{DGS}$	R <sub>DS(ON)</sub> (max)	l <sub>DSS</sub> (min)
120V	6.0Ω	1.0A

## **Pin Configuration**



## **Product Marking**



Package may or may not include the following marks: Si or \$\infty\$



TO-92

### **Thermal Characteristics**

Package	l <sub>□</sub> (continuous) <sup>†</sup>	I <sub>D</sub> (pulsed)	Power Dissipation @T <sub>c</sub> = 25°C	l <sub>DR</sub> †	I <sub>DRM</sub>	
TO-92	230mA	2.0A	1.0W	230mA	2.0A	

#### Notes:

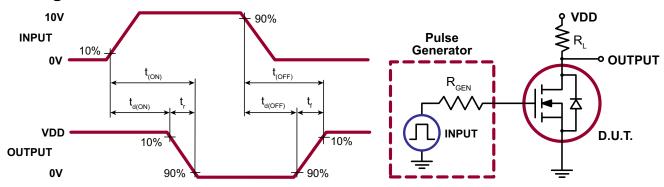
# **Electrical Characteristics** (T<sub>A</sub> = 25°C unless otherwise specified)

Sym	Parameter		Тур	Max	Units	Conditions	
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	120	-	-	V	$V_{GS} = 0V, I_{D} = 100 \mu A$	
$V_{\rm GS(th)}$	Gate threshold voltage	8.0	-	2.0	V	$V_{GS} = V_{DS}$ , $I_D = 1.0 \text{mA}$	
I <sub>GSS</sub>	Gate body leakage	-	-	100	nA	$V_{GS} = \pm 15V, V_{DS} = 0V$	
		-	-	10		$V_{GS} = 0V, V_{DS} = Max Rating$	
I <sub>DSS</sub>	Zero gate voltage drain current	-	-	500	μA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0$ V, $T_A = 125$ °C	
I <sub>D(ON)</sub>	On-state drain current	1.0	-	-	Α	$V_{GS} = 10V, V_{DS} = 10V$	
D	Statio drain to source on state registance	-	-	10	_	$V_{GS} = 2.5V, I_{D} = 100mA$	
R <sub>DS(ON)</sub>	Static drain-to-source on-state resistance		-	6.0	Ω	$V_{GS} = 10V, I_{D} = 500mA$	
$G_{FS}$	Forward transductance	300	-	-	mmho	$V_{DS} = 10V, I_{D} = 500mA$	
C <sub>iss</sub>	Input capacitance	-	-	125		$V_{GS} = 0V$ ,	
C <sub>oss</sub>	Common source output capacitance	-	-	50	pF	$V_{DS} = 25V$ ,	
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	20		f = 1.0MHz	
t <sub>r</sub>	Rise time	-	-	8.0			
t <sub>d(ON)</sub>	Turn-on delay time	-	-	8.0	ns	$V_{DD} = 60V,$ $I_{D} = 400mA,$ $R_{GEN} = 25\Omega$	
t <sub>f</sub>	Fall time	-	-	12			
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	18			
$V_{\scriptscriptstyle{SD}}$	Diode forward voltage drop	-	1.2	-	V	$V_{GS} = 0V$ , $I_{SD} = 250$ mA	

#### Notes:

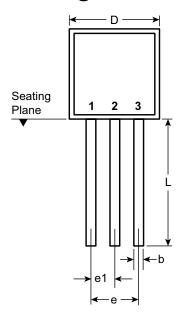
- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

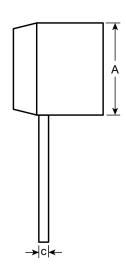
# **Switching Waveforms and Test Circuit**



<sup>†</sup>  $I_D$  (continuous) is limited by max rated  $T_i$ .

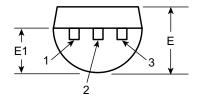
# 3-Lead TO-92 Package Outline (L)





**Front View** 

Side View



**Bottom View** 

Symb	ool	Α	b	С	D	E	E1	е	e1	L
Dimensions (inches)	MIN	.170	.014 <sup>†</sup>	.014 <sup>†</sup>	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 <sup>†</sup>	.022 <sup>†</sup>	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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<sup>\*</sup> This dimension is not specified in the JEDEC drawing.

<sup>†</sup> This dimension differs from the JEDEC drawing.